



Product Change Notification

112345 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112345 - 00
Change Title: Intel® Server System R1304GL4DS9 and R1304GZ4GC
PCN 112345-00, Product Design Update System Rear Panel
Date of Publication: June 05, 2013

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jun 30, 2013
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Description of Change to the Customer:

Intel has implemented the following changes on Intel® Server System R1304GL4DS9 and R1304GZ4GC:

1. Add a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.
2. Update the system rear panel so that more PCIe devices and cable connectors (e.g. SFP+ PCIe card) can mechanically fit into the system.

Customer Impact of Change and Recommended Action:

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

Products Affected / Intel Ordering Codes:

EMEA SKUs			
Product Code	MM#	Pre Change TA	Post Change TA
R1304GZ4GC	916994	G50533-004	G50533-005
R1304GL4DS9	922790	G67853-001	G67853-002

PCN Revision History:

Date of Revision: June 5, 2013	Revision Number: 00	Reason: Originally Published PCN
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